Power MOSFET –20V, 266mΩ, –1.5A, Single P-Channel with Schottky Diode

MCH5839 is a P-Channel Power MOSFET, with Schottky Diode for general-purpose switching device applications.

Features

- Composite type with a P-Channel silicon MOSFET and a schottky barrier diode contained in one package facilitating high-density mounting
- Pb-Free, Halogen Free and RoHS compliance

[MOSFET]

- Low On-resistance
- ESD Diode-Protected Gate
- 1.8V drive

[SBD]

- Short reverse recovery time
- Low forward voltage

Typical Applications

• DC/DC Converter

SPECIFICATIONS

ABSOLUTE MAXIMUM RATING at Ta = 25°C (Note 1)

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Parameter	Symbol	Value	Unit		
[MOSFET]					
Drain to Source Voltage	VDSS	-20	V		
Gate to Source Voltage	VGSS	±10	V		
Drain Current (DC)	ID	-1.5	Α		
Drain Current (Pulse) PW ≤ 10µs, duty cycle ≤ 1%	IDP	-6	Α		
Power Dissipation When mounted on ceramic substrate (1000mm² × 0.8mm) 1unit	PD	0.8	W		
Junction Temperature	Tj	150	°C		
Storage Temperature	Tstg	-55 to +125	°C		
[SBD]					
Repetitive Peak Reverse Voltage	VRRM	15	V		
Nonrepetitive Peak Reverse Surge Voltage	VRSM	15	V		
Average Output Current	IO	1	Α		
Surge Forward Current 50Hz sine wave, 1cycle	IFSM	3	Α		
Junction Temperature	Tj	-55 to +125	°C		
Storage Temperature	Tstg	–55 to +125	°C		

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit			
Junction to Ambient	Б	450.0	0000			
When mounted on ceramic substrate (1000mm ² × 0.8mm) 1unit	$R_{\theta JA}$	156.2	°C/W			



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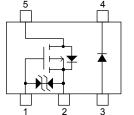
MOSFET

١	/DSS	R _{DS} (on) Max	I _D Max
		266mΩ@ -4.5V	
	-20V	413mΩ@ –2.5V	-1.5A
		645mΩ@ -1.8V	

SCHOTTKY DIODE

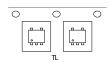
VRRM	V _F Max	IFSM
15V	0.46V	3A

ELECTRICAL CONNECTION P-Channel



- 1:Gate
- 2 : Source 3 : Anode
- 3: Anode 4: Cathode
- 5 : Drain

PACKING TYPE : TL MARKING





ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

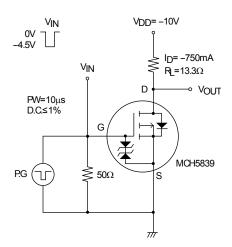
ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 2)

Parameter	Symbol	Symbol Conditions	Value			Unit	
Parameter	Symbol	Conditions	min	typ	max	Ullit	
[MOSFET]							
Drain to Source Breakdown Voltage	V(BR)DSS	ID=-1mA, VGS=0V	-20			V	
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =-20V, V _{GS} =0V			-1	μА	
Gate to Source Leakage Current	IGSS	V _{GS} =±8V, V _{DS} =0V			±10	μΑ	
Gate Threshold Voltage	VGS(th)	V _{DS} =-10V, I _D =-1mA	-0.4		-1.4	V	
Forward Transconductance	9FS	V _{DS} =-10V, I _D =-750mA		1.9		S	
	R _{DS} (on)1	ID=-750mA, VGS=-4.5V		205	266	mΩ	
Static Drain to Source On-State Resistance	R _{DS} (on)2	ID=-300mA, VGS=-2.5V		295	413	mΩ	
Resistance	R _{DS} (on)3	I _D =-100mA, V _G S=-1.8V		430	645	mΩ	
Input Capacitance	Ciss			120		pF	
Output Capacitance	Coss	V _{DS} =-10V, f=1MHz		26		pF	
Reverse Transfer Capacitance	Crss			20		pF	
Turn-ON Delay Time	t _d (on)			5.3		ns	
Rise Time	t _r	Con amonified Took Circuit		9.7		ns	
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit		16		ns	
Fall Time	tf			14		ns	
Total Gate Charge	Qg			1.7		nC	
Gate to Source Charge	Qgs	V _{DS} =-10V, V _{GS} =-4.5V, I _D =-1.5A		0.28		nC	
Gate to Drain "Miller" Charge	Qgd			0.47		nC	
Forward Diode Voltage	V _{SD}	I _S =-1.5A, V _{GS} =0V		-0.89	-1.2	V	
[SBD]				•			
Reverse Voltage	VR	I _R =0.5mA	15			V	
Forward Voltage	VF	I _F =0.5A		0.4	0.46	V	
Reverse Current	lR	V _R =6V			90	μΑ	
Interterminal Capacitance	С	V _R =10V, f=1MHz		13		pF	
Reverse Recovery Time	t _{rr}	IF=IR=100mA, See specified Test Circuit			10	ns	

Note 2 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

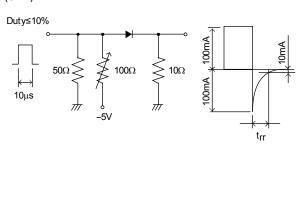
Switching Time Test Circuit

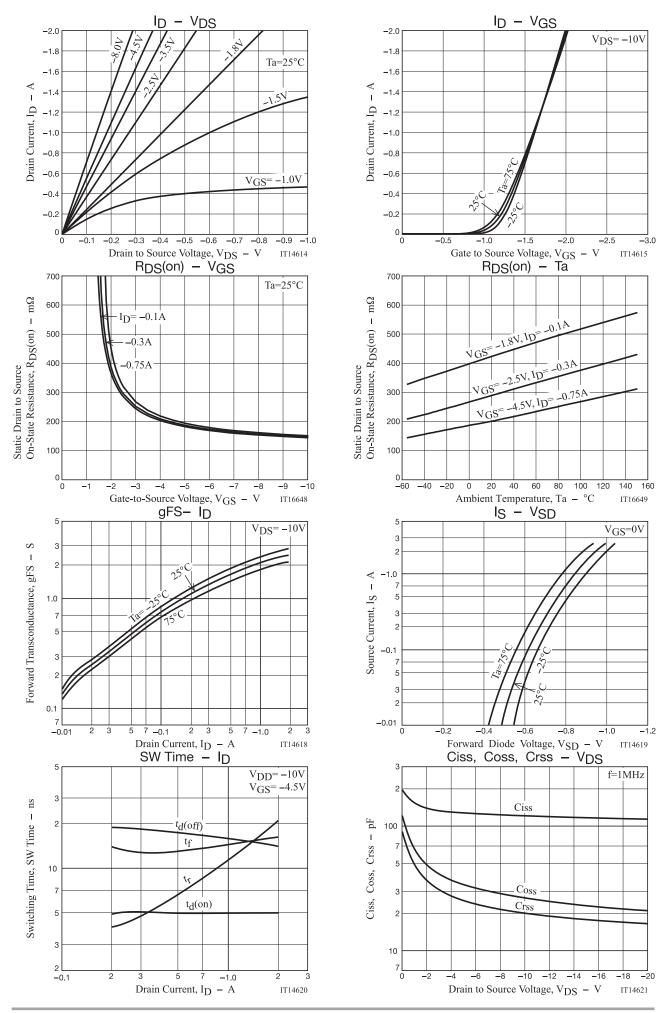
(MOSFET)

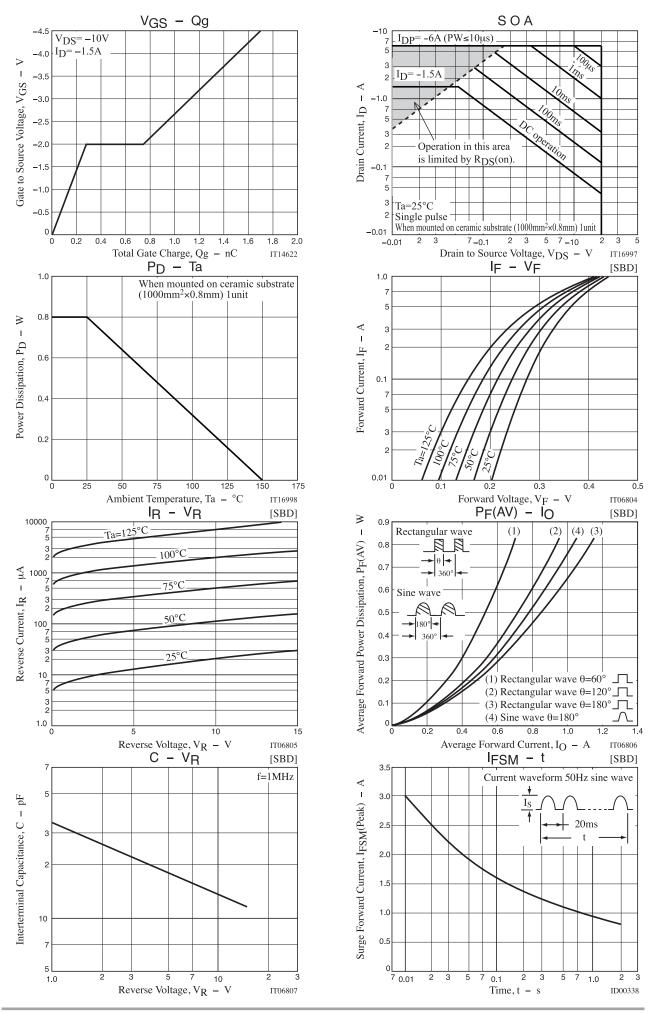


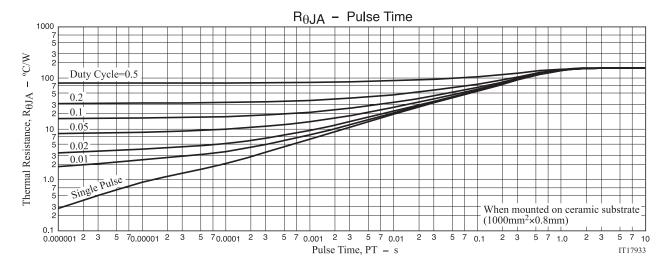
t_{rr} Test Circuit

(SBD)



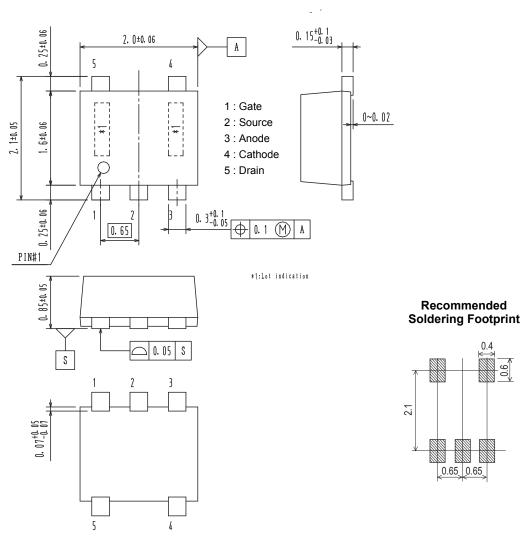






PACKAGE DIMENSIONS

unit: mm SC-88AFL / MCPH5 CASE 419AP ISSUE O



ORDERING INFORMATION

Device	Device Marking		Shipping (Qty / Packing)	
MCH5839-TL-H	VD	SC-88AFL / MCPH5	2 000 / Tara & Daal	
MCH5839-TL-W		(Pb-Free / Halogen Free)	3,000 / Tape & Reel	

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub link/Collateral/BRD8011-D.PDF

Note on usage: Since the MCH5839 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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